

SILICON CARBIDE SCHOTTKY DIODE

Description:

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material-Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over_voltage conditions.



IATF16949认证



AEC-Q101 Qualified

Features:

- Max Junction Temperature 175° C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- AEC-Q101 qualified and PPAP capable

Mechanical Data:

- Case: JEDEC TO-252
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked

TO-252
KJSC1065M2-V



Applications:

- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

KEY PERFORMANCE AND PACKAGE PARAMETERS

Type	V_{DC}	I_F	Q_c	$T_{j,max}$	Package
KJSC1065M2-V	650V	10A	25nC	175°C	TO- 252

RATINGS AND CHARACTERISTIC OF KJSC1065M2-V

MAXIMUM RATINGS

(Ratings at 25° C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	650	V
Continuous Forward Current for $R_{th(j-c)}$	I_F	10 ($T_c \leq 135^\circ\text{C}$ TO-252)	A
Non-Repetitive Forward Surge Current (Half-Sine Pulse, $t_p=8.3\text{ms}$)	$I_{F,SM}$	85(25°C) 75(150°C)	A
I^2t value	$\int i^2t$	30 (25°C) 23 (150°C)	A^2S
Diode dv/dt ruggedness($V_R=0\dots650\text{V}$)	dv/dt	80	V/nS
Power dissipation for $R_{th(j-c,max)}$ ($T_c=25^\circ\text{C}$)	P_{tot}	60	W
Operating junction temperature range	T_j	-55...175	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55...175	$^\circ\text{C}$

THERMAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	TO-252	Unit
Diode thermal resistance junction-case	$R_{th(j-c)}$	2.5	K/W

RATINGS AND CHARACTERISTIC OF KJSC1065M2-V

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
DC blocking voltage	V _{DC}	T _j =25...175°C	650			V
Diode forward voltage	V _F	IF= 10A T _j =25°C IF=10A T _j = 125°C IF=10A T _j = 175°C		1.5 1.6 1.8	1.8 1.9 2.1	V
Reverse current	I _R	VR=650V T _j =25°C VR= 650V T _j = 125°C VR= 650V T _j = 175°C			20 100 200	uA

DYNAMIC CHARACTERISTICS(at T_j= 25°C, unless otherwise specified)

Parameter	Symbol	conditions	Value			Unit
			min	typ	max	
Total capacitive charge	Q _c	VR=650V,IF=10A di/dt=200A/uS T _j =25°C		25		nC
Total capacitance	C	V _R =0V,f=1MHz V _R =200V,f=1MHz V _R =400V,f=1MHz T _j =25°C		440 57 46		pF

RATINGS AND CHARACTERISTIC OF KJSC1065M2-V

FIG.1-FORWARD CURRENT DERATING CURVE

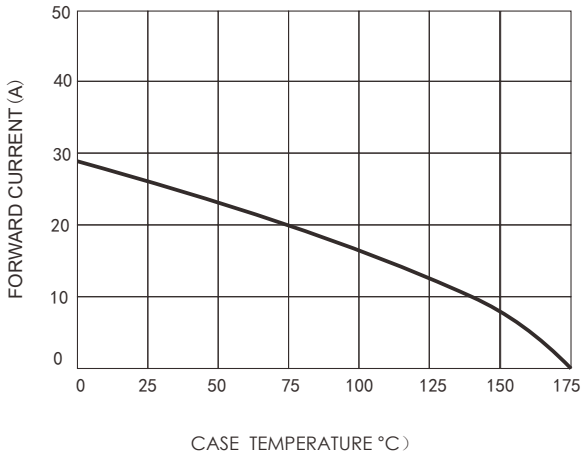


FIG.2-TYPICAL JUNCTION CAPACITANCE

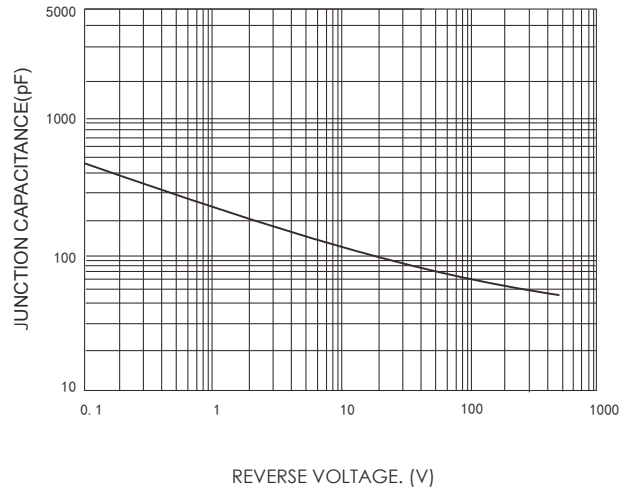


FIG.3-FORWARD CHARACTERISTICS

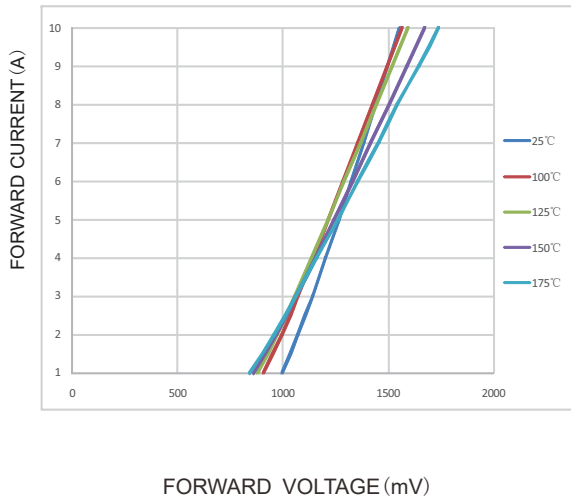
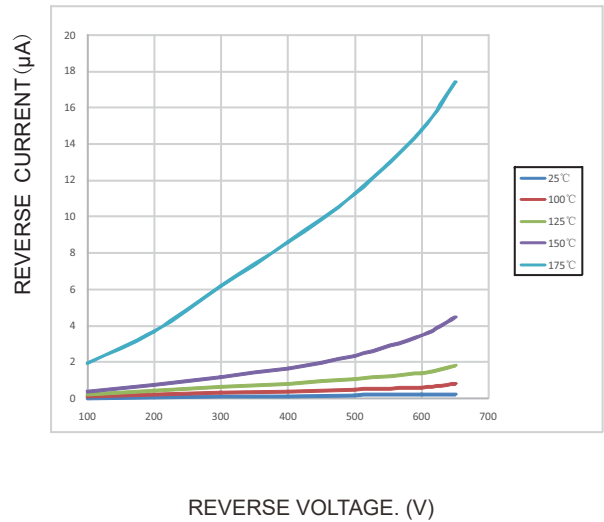
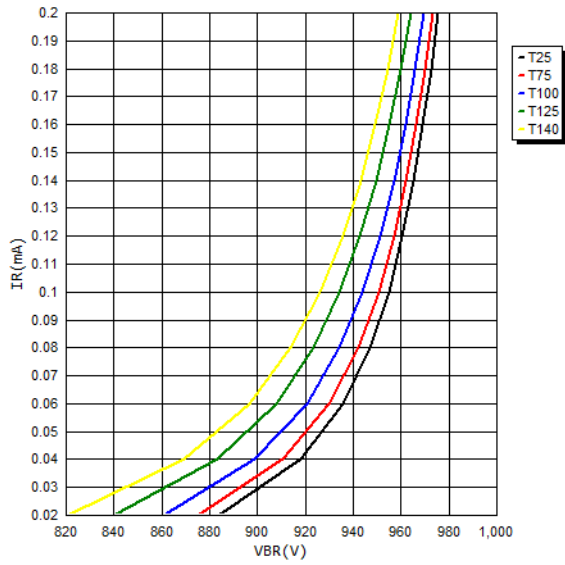


FIG.4-REVERSE CHARACTERISTICS (IR:0-20uA)



RATINGS AND CHARACTERISTIC OF KJSC1065M2-V

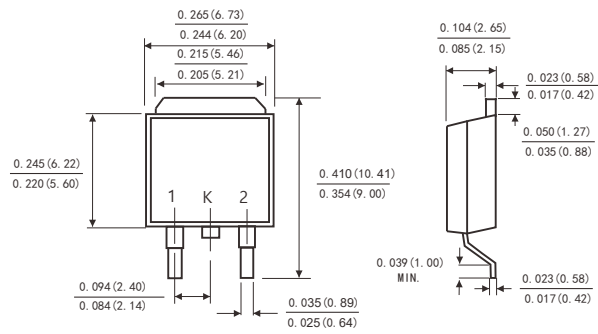
FIG.5-REVERSE CHARACTERISTICS (IR:0.02-0.2mA)



PACKAGE OUTLINE DIMENSIONS

Dimensions in inches and (millimeters)

TO-252



Suggested Pad Layout

(TO-252)

